Dual DPDT Ultra-Low R_{ON} Switch

The NLAS3799B is an ultra–low R_{ON} dual DPDT and a 0.5 Ω R_{ON} analog switch. This device is designed for low operating voltage, high current switching of speaker output and earpiece for cellphone applications. It can switch a balanced stereo output. The NLAS3799B can handle a balanced microphone/speaker/ring–tone generator in a monophone mode. The device contains a break–before–make (BBM) feature.

Features

- Single Supply Operation

 1.65 to 4.5 V V_{CC}

 Function Directly from LiON Battery
- Maximum Breakdown Voltage: 5.5 V
- Low Static Power
- NLAS3799B Interfaces with 2.8 V Chipset NLAS3799BL Interfaces with 1.8 V Chipset
- These are Pb–Free Devices

Typical Applications

- Cell Phone Speaker/Microphone Switching
- Ringtone-Chip/Amplifier Switching
- Four Unbalanced (Single-Ended) Switches
- Stereo Balanced (Push-Pull) Switching

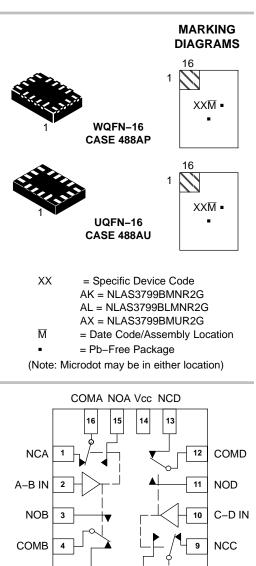
Important Information

- ESD Protection: HBM (Human Body Model) > 8000 V MM (Machine Model) > 400 V
- Continuous Current Rating Through each Switch ±300 mA
- Conforms to: JEDEC MO-220, Issue H, Variation VEED-6
- Package:
 - ◆ 1.8 x 2.6 x 0.75 mm WQFN-16 Pb-Free
 - 1.8 x 2.6 x 0.55 mm UQFN-16 Pb-Free



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 NCB GND NOCCOMC

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

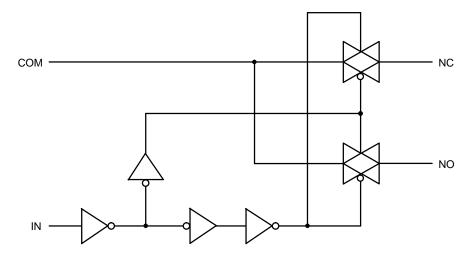


Figure 1. Input Equivalent Circuit

PIN DESCRIPTION

QFN PIN #	Symbol	Name and Function
1, 3, 5, 7, 9, 11, 13, 15	NO A–D, NC A–D	Independent Channels
2, 10	A–B IN, C–D IN	Controls
4, 8, 12, 16	COM A-D	Common Channels
6	GND	Ground (V)
14	V _{CC}	Positive Supply Voltage

TRUTH TABLE

IN	NO	NC		
н	ON	OFF*		
L	OFF*	ON		

*High impedance.

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Positive DC Supply Voltage	-0.5 to +5.5	V
V _{IS}	Analog Input Voltage (V _{NO} , V _{NC} , or V _{COM})	$-0.5 \le V_{IS} \le V_{CC} + 0.5$	V
V _{IN}	Digital Select Input Voltage	$-0.5 \le V_{IN} \le +V_{CC}$	V
I _{anl1}	Continuous DC Current from COM to NC/NO	±300	mA
I _{anl-pk1}	Peak Current from COM to NC/NO, 10 Duty Cycle (Note 1)	±500	mA
I _{cImp}	Continuous DC Current into COM/NO/NC with Respect to V_{CC} or GND	±100	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability. 1. Defined as 10% ON, 90% OFF Duty Cycle.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage	1.65	4.5	V
V _{IN}	Digital Select Input Voltage	GND	V _{CC}	V
V _{IS}	Analog Input Voltage (NC, NO, COM)	GND	V _{CC}	V
T _A	Operating Temperature Range	-40	+85	°C
t _r , t _f	Input Rise or Fall Time, IN $ \begin{array}{c} V_{CC} = 1.6 \ V - 2.7 \ V \\ V_{CC} = 3.0 \ V - 4.5 \ V \end{array} $		20 10	ns/V

NLAS3799B DC CHARACTERISTICS - DIGITAL SECTION (Voltages Referenced to GND)

				Guara	anteed Limit	
Symbol	Parameter	Condition	V _{CC}	25°C	–40°C to +85°C	Unit
V _{IH}	Minimum High-Level Input Voltage, Select Inputs		3.0 4.3	1.4 2.0	1.4 2.0	V
V _{IL}	Maximum Low–Level Input Voltage, Select Inputs		3.0 4.3	0.5 0.8	0.5 0.8	V
I _{IN}	Maximum Input Leakage Current, Select Inputs	$V_{IN} = V_{CC}$ or GND	4.3	±0.1	±1.0	μΑ
I _{OFF}	Power Off Leakage Current	V _{IN} = 4.5 V or GND	0	±0.5	±2.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (Note 2)	Select and $V_{IS} = V_{CC}$ or GND	1.65 to 4.5	±1.0	±2.0	μΑ

2. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

NLAS3799B DC ELECTRICAL CHARACTERISTICS - ANALOG SECTION

				Gua	Guaranteed Maximum Limit			
				25	25°C -40°C to +		o +85°C	
Symbol	Parameter	Condition	Vcc	Min	Max	Min	Max	Unit
R _{ON}	NC/NO On–Resistance (Note 3)		3.0 4.3		0.5 0.4		0.6 0.5	Ω
R _{FLAT}	NC/NO On–Resistance Flatness (Notes 3 and 4)	$I_{COM} = 100 \text{ mA}$ $V_{IS} = 0 \text{ to } V_{CC}$	3.0 4.3		0.15 0.15		0.15 0.15	Ω
ΔR _{ON}	On–Resistance Match Between Channels (Notes 3 and 5)	$V_{IS} = 1.5 V;$ $I_{COM} = 100 mA$ $V_{IS} = 2.2 V;$ $I_{COM} = 100 mA$	3.0 4.3		0.05 0.05		0.05 0.05	Ω
I _{NC(OFF)} I _{NO(OFF)}	NC or NO Off Leakage Current (Note 3)		4.3	-10	10	-100	100	nA
I _{COM(ON)}	COM ON Leakage Current (Note 3)		4.3	-10	10	-100	100	nA

3. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

4. Flatness is defined as the difference between the maximum and minimum value of On-resistance as measured over the specified analog signal ranges. 5. $\Delta R_{ON} = R_{ON(MAX)} - R_{ON(MIN)}$ between NCn or NOn.

				Guara	anteed Limit	
Symbol	Parameter	Condition	V _{CC}	25°C	–40 to +85°C	Unit
V _{IH}	Minimum High-Level Input Voltage, Select Inputs		3.0 4.3	1.3 1.6	1.3 1.6	V
V _{IL}	Maximum Low-Level Input Voltage, Select Inputs		3.0 4.3	0.5 0.6	0.5 0.6	V
I _{IN}	Maximum Input Leakage Current, Select Inputs	$V_{IN} = V_{CC}$ or GND	4.3	±0.1	±1.0	μΑ
I _{OFF}	Power Off Leakage Current	V _{IN} = 4.5 V or GND	0	±0.5	±2.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (Note 6)	Select and $V_{IS} = V_{CC}$ or GND	1.65 to 4.3	±40	±45	μΑ

NLAS3799BL DC CHARACTERISTICS – DIGITAL SECTION (Voltages Referenced to GND)

6. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

NLAS3799BL DC ELECTRICAL CHARACTERISTICS – ANALOG SECTION

				Gua	ranteed	Maximur	n Limit	
				25	°C	-40°C t	o +85°C	
Symbol	Parameter	Condition	V _{CC}	Min	Max	Min	Max	Unit
R _{ON}	NC/NO On–Resistance (Note 7)		3.0 4.3		0.5 0.4		0.6 0.5	Ω
R _{FLAT}	NC/NO On–Resistance Flatness (Notes 7 and 8)	$I_{COM} = 100 \text{ mA}$ $V_{IS} = 0 \text{ to } V_{CC}$	3.0 4.3		0.15 0.15		0.15 0.15	Ω
ΔR_{ON}	On-Resistance Match Between Channels (Notes 7 and 9)	$V_{IS} = 1.5 V; \\ I_{COM} = 100 \text{ mA} \\ V_{IS} = 2.2 V; \\ I_{COM} = 100 \text{ mA} \end{cases}$	3.0 4.3		0.05 0.05		0.05 0.05	Ω
I _{NC(OFF)} I _{NO(OFF)}	NC or NO Off Leakage Current (Note 7)	$ \begin{array}{l} V_{IN} = V_{IL} \text{ or } V_{IH} \\ V_{NO} \text{ or } V_{NC} = 0.3 \ V \\ V_{COM} = \ 4.0 \ V \end{array} $	4.3	-10	10	-100	100	nA
I _{COM(ON)}	COM ON Leakage Current (Note 7)	$\label{eq:VIN} \begin{array}{l} V_{IN} = V_{IL} \mbox{ or } V_{IH} \\ V_{NO} \mbox{ 0.3 V or } 4.0 \mbox{ V with} \\ V_{NC} \mbox{ floating or } \\ V_{NO} \mbox{ 0.3 V or } 4.0 \mbox{ V with} \\ V_{NO} \mbox{ floating } \\ V_{COM} = 0.3 \mbox{ V or } 4.0 \mbox{ V} \end{array}$	4.3	-10	10	-100	100	nA

7. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.

8. Flatness is defined as the difference between the maximum and minimum value of On-resistance as measured over the specified analog signal ranges.

9. $\Delta \ddot{R}_{ON} = R_{ON(MAX)} - R_{ON(MIN)}$ between NC1 and NC2 or between NO1 and NO2.

NLAS3799B/NLAS3799BL AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ ns}$)

					Gua	rantee	d Maxi	mum l	imit	
			V _{CC} V _{IS}			25°C		_	°C to 5°C	
Symbol	Parameter	Test Conditions	(V)	(V)	Min	Тур*	Max	Min	Max	Unit
t _{ON}	Turn–On Time	$R_L = 50 \Omega$, $C_L = 35 pF$ (Figures 3 and 4)	2.3 – 4.3	1.5			50		60	ns
t _{OFF}	Turn–Off Time	$R_L = 50 \Omega$, $C_L = 35 pF$ (Figures 3 and 4)	2.3 - 4.3	1.5			30		40	ns
t _{BBM}	Minimum Break–Before–Make Time	$V_{IS} = 3.0$ $R_{L} = 50 \ \Omega$, $C_{L} = 35 \ pF$ (Figure 2)	3.0	1.5	2	15				ns

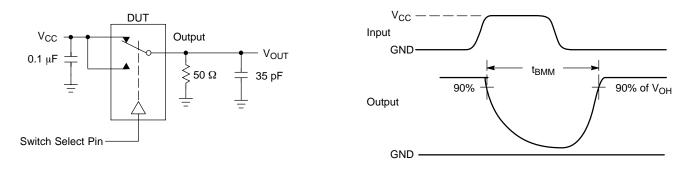
		Typical @ 25, V _{CC} = 3.6 V	
C _{IN}	Control Pin Input Capacitance	3.0	pF
C _{SN}	SN Port Capacitance	72	pF
CD	D Port Capacitance When Switch is Enabled	220	pF

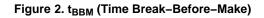
*Typical Characteristics are at 25°C.

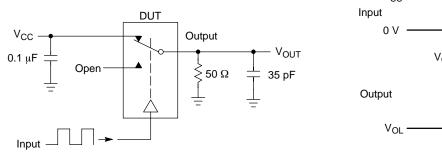
ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)

			V _{CC}	25°C	
Symbol	Parameter	Condition	(V)	Typical	Unit
BW	Maximum On–Channel –3 dB Bandwidth or Minimum Frequency Response (Figure 9)	V_{IN} centered between V_{CC} and GND (Figure 5)	1.65 – 4.5	19	MHz
V _{ONL}	Maximum Feed-through On Loss	V_{IN} = 0 dBm @ 100 kHz to 50 MHz V_{IN} centered between V_{CC} and GND (Figure 5)	1.65 – 4.5	-0.06	dB
V _{ISO}	Off–Channel Isolation	f = 100 kHz; V_{IS} = 1 V RMS; C_L = 5.0 pF V_{IN} centered between V_{CC} and GND(Figure 5)	1.65 – 4.5	-69	dB
Q	Charge Injection Select Input to Common I/O (Figure 8)	$V_{IN} = V_{CC to} \text{ GND}, R_{IS} = 0 \Omega, C_L = 1.0 \text{ nF}$ Q = C _L x ΔV_{OUT} (Figure 6)	1.65 – 4.5	51	рС
THD	Total Harmonic Distortion THD + Noise (Figure 7)	F_{IS} = 20 Hz to 20 kHz, R_L = R_{gen} = 600 Ω,C_L = 50 pF V_{IS} = 2 V_{PP}	4.3	0.042	%
VCT	Channel-to-Channel Crosstalk (Figure 10)	f = 100 kHz; V _{IS} = 1.0 V RMS, C _L = 5.0 pF, R _L = 50 Ω V _{IN} centered between V _{CC} and GND (Figure 5)	1.65 – 4.5	-90	dB

10. Off-Channel Isolation = 20log10 (V_{COM}/V_{NO}), V_{COM} = output, V_{NO} = input to off switch.







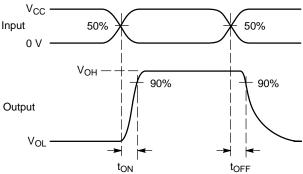
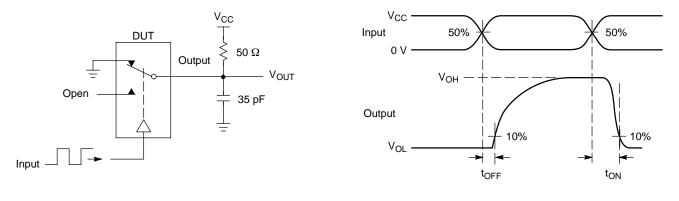
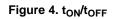
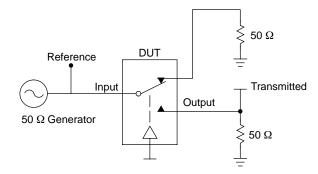


Figure 3. t_{ON}/t_{OFF}





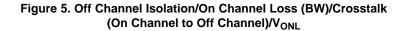


Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. V_{ISO} , Bandwidth and V_{ONL} are independent of the input signal direction.

$$\begin{split} & \mathsf{V}_{\text{ISO}} = \text{Off Channel Isolation} = 20 \text{ Log } \left(\frac{\mathsf{V}\text{OUT}}{\mathsf{V}\text{IN}}\right) \quad \text{for } \mathsf{V}_{\text{IN}} \text{ at } 100 \text{ kHz} \\ & \mathsf{V}_{\text{ONL}} = \text{On Channel Loss} = 20 \text{ Log } \left(\frac{\mathsf{V}\text{OUT}}{\mathsf{V}\text{IN}}\right) \quad \text{for } \mathsf{V}_{\text{IN}} \text{ at } 100 \text{ kHz} \text{ to } 50 \text{ MHz} \end{split}$$

Bandwidth (BW) = the frequency 3 dB below V_{ONL}

 V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω



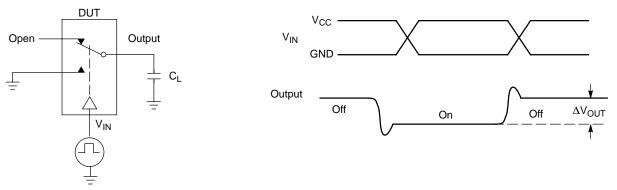
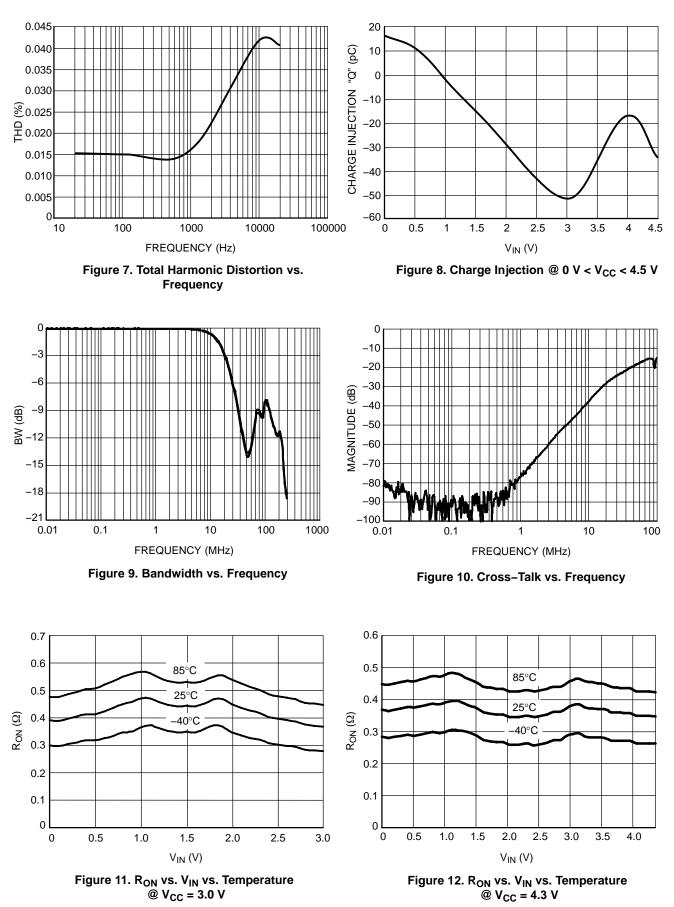


Figure 6. Charge Injection: (Q)



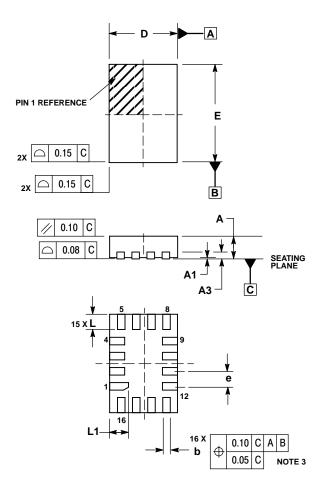
DEVICE ORDERING INFORMATION

		Devi	evice Nomenclature				
Device Order Number	Circuit Indicator	Technology	Device Function	Package Suffix	Tape & Reel Suffix	Package Type	Tape & Reel Size [†]
NLAS3799BMNR2G	NL	AS	3799B	MN	R2	WQFN-16 (Pb-Free)	3000 / Tape & Reel
NLAS3799BLMNR2G	NL	AS	3799BL	MN	R2	WQFN-16 (Pb-Free)	3000 / Tape & Reel
NLAS3799BMUR2G	NL	AS	3799	MU	R2	UQFN-16 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

WQFN16 (1.8x2.6x0.4P) CASE 488AP-01 **ISSUE A**

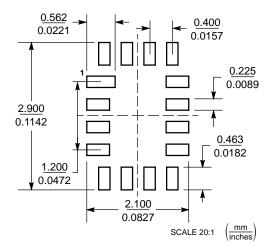


NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS 3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM CONTREMNMO

- AND IS MEASONED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL. 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS. 5. EXPOSED PADS CONNECTED TO DIE FLAG. USED AS TEST CONTACTS.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.70	0.80
A1	0.00	0.050
A3	0.20 REF	
b	0.15	0.25
D	1.80 BSC	
Е	2.60 BSC	
е	0.40 BSC	
L	0.30	0.50
L1	0.40	0.60

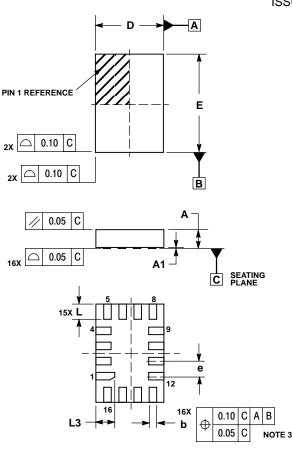
MOUNTING FOOTPRINT



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

16 PIN UQFN, 1.8x2.6, 0.4P CASE 488AU–01 ISSUE O

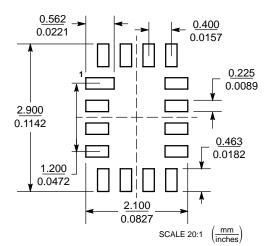


NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS 3. DIMENSION b APPLIES TO PLATED TERMINAL
- AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL
- 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.45	0.55
A1	0.00	0.05
b	0.15	0.25
D	1.80 BSC	
Е	2.60 BSC	
е	0.40 BSC	
L	0.30	0.50
L3	0.40	0.60

MOUNTING FOOTPRINT*



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